

MS 23 N2 0 Z

20V N-Channel MOSFETs

Description

These N-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

Features

- 20V,500mA, RDS(ON) = $350m\Omega@VGS = 4.5V$
- Worldwide Smallest Package: 1x0.6x0.45 mm
- Fast switching
- Green Device Available
- Suit for 1.2V Gate Drive Applications
- 2KV HBM ESD Capability
- RoHS compliant package

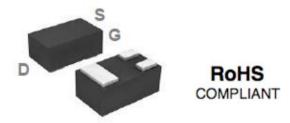
Application

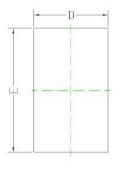
- Notebook
- · Load Switch
- Battery Protection
- Hand-held Instruments

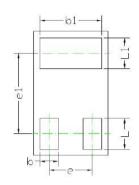
Package type: SOT-883

Packing & Order Information

3,000/Reel





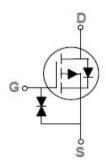


SIDE VIEW



2		СПИМПИ				
S	COMMON					
B D L	DIMENS	DIMENSIONS MILLIMETER				
L	MIN	NDM.	MAX			
Α	0.40	0.45	0.50			
АЗ	().127 BS	С			
D	0.55	0.60	0,65			
E	0.95	1.00	1.05			
е	(),35 BSC				
e1	().65 BSC	;			
b	0.13	0.15	0.18			
b1	0.45	0.50	0.55			
L	0.20	0.25	0.30			
L1	0.20	0.25	0.30			

Graphic symbol





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MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Absolute Maximum Ratings (Tc=25°C unless otherwise noted)						
Symbol	Parameter	Value	Unit			
$V_{DS} \\$	Drain-Source Voltage	20	V			
V_{GS}	Gate-Source Voltage	±8	V			
T_	Drain Current -Continuous (TC=25°C)	500	mA			
ID	Drain Current -Continuous (TC=100°C)	320	mA			
I_{DM}	Drain Current Pulsed ¹	1000	mA			
PD	Power Dissipation (TC=25°C)	155	mW			
	Power Dissipation - Derate above 25°C	1.25	mW/°C			
T _J	Storage Temperature Range	-55 to 150	°C			
T _{STG}	Operating Junction Temperature Range	-55 to 150	°C			

Thermal Resistance Characteristics					
Symbol	Parameter	Тур.	Max.	Units	
$R_{\theta JA}$	Thermal Resistance Junction to ambient		800	°C/W	

Electrical Characteristics (TJ=25°C, unless otherwise noted)

On Characteristics							
Symbol	Parameter	Test Conditions	Min	Тур.	Max.	Units	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{\rm DS}=V_{\rm GS}$, ${\rm I}_{\rm D}=250\mu A$	0.3	0.5	0.8	V	
$\Delta V_{GS(th)}$	V _{GS(th)} Temperature Coefficient			3		mV/°C	
Rds(on)	Static Drain-Source On-Resistance	$V_{GS} = 4.5 \text{ V}, I_D = 0.5 \text{ A}$		200	350	- mΩ	
		$V_{GS} = 2.5 \text{ V}, I_{D} = 0.4 \text{ A}$		235	450		
		$V_{GS} = 1.8 \text{ V}, I_{D} = 0.2 \text{ A}$		295	600	11122	
		$V_{GS} = 1.5 \text{ V}, I_D = 0.1 \text{ A}$		365	800		
		$V_{GS} = 1.2 \text{ V}, I_{D} = 0.1 \text{ A}$		600	1500	V	

Off Characteristics						
Symbol	Parameter	Test Conditions	Min	Тур.	Max.	Units
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS}=0~V$, I_D =250 μ A	20			V
ΔBV_{DSS} $/\Delta T_J$	BV _{DSS} Temperature Coefficient	$I_D = 1 mA$, Referenced to $25^{\circ}C$		0.01		V/°C
I _{DS S}	Drain-Source Leakage Current	$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 125 ^{\circ}\text{C}$ $V_{DS} = 16 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 125 ^{\circ}\text{C}$			1 10	uA
Igss	Gate-Source Leakage Current	$V_{GS} = \pm 8 \text{ V}, V_{DS} = 0 \text{ V}$			±20	uA



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Dynamic Characteristics							
Symbol	Parameter	Test Conditions	Min	Тур.	Max.	Units	
Q_{g}	Total Gate Charge ^{2,3}			1	2	nC	
Q_{gs}	Gate-Source Charge 2,3	$V_{DS} = 10 \text{ V}, I_D = 0.5 \text{ A},$ $V_{GS} = 4.5 \text{ V}$		0.26	0.5	nC	
$Q_{\rm gd}$	Gate-Drain Charge ^{2,3}	VGS - 4.3 V		0.2	0.4	nC	
$T_{d(on)} \\$	Turn-On Time ^{2,3}	$V_{DD} = 10 \text{ V}, \ I_D = 0.5 \text{ A}, \\ R_G = 10 \ \Omega \ , \ V_{GS} = 4.5 \text{ V}$		5	10	ns	
$T_{\rm r}$	Turn-On Time ^{2,3}			3.5	7	ns	
$T_{d(off)} \\$	Turn-Off Delay Time ^{2,3}			14	28	ns	
Tf	Turn-Off Fall Time ^{2,3}			6	12	ns	
C _{ISS}	Input Capacitance	$V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V},$ $F = 1.0 \text{MHz}$		38.2	75	pF	
Coss	Output Capacitance			14.4	28	pF	
Crss	Reverse Transfer Capacitance			6	12	pF	

Drain-Source Diode Characteristics and Maximum Ratings							
Symbol	Parameter	Test Conditions	Min	Typ.	Max.	Units	
Is	Continuous Source Current				500		
I_{SM}	Pulsed Source Current	$V_G=V_D=0V$, Force Current			1000	mA	
V_{SD}	Diode Forward Voltage	$I_S = 0.2 \text{ A}$, $V_{GS} = 0 \text{ V}$, $T_J = 125 ^{\circ}\text{C}$			1	V	

Notes;

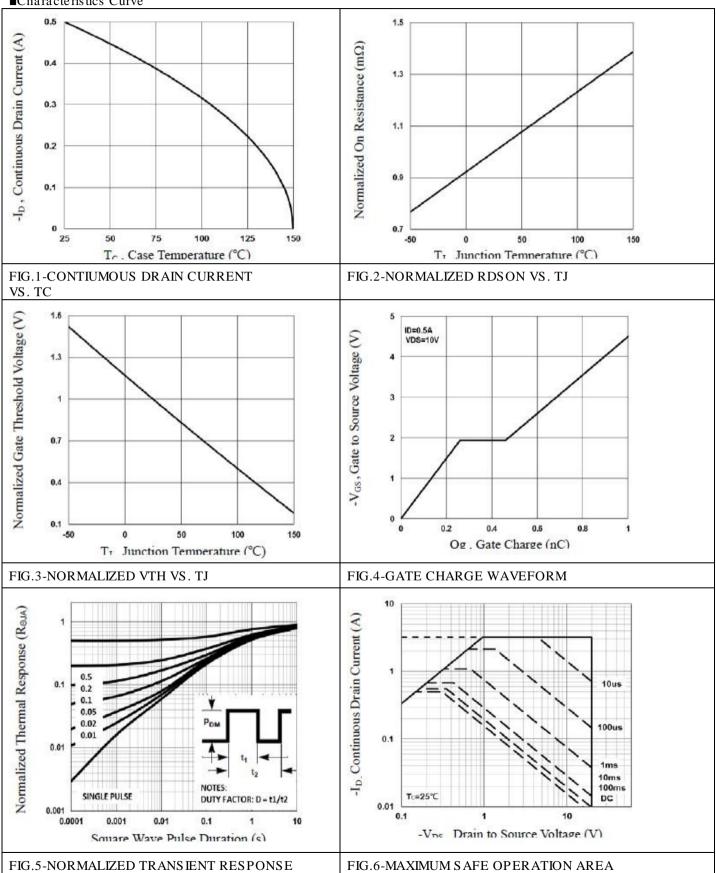
- 1. Repetitive Rating: Pulsed width limited by maximum junction temperature.
- 2. The data tested by pulsed , pulse width $\leq 300 \, \text{us}$, duty cycle $\leq 2\%$.
- 3. Essentially independent of operating temperature.



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■Characteristics Curve

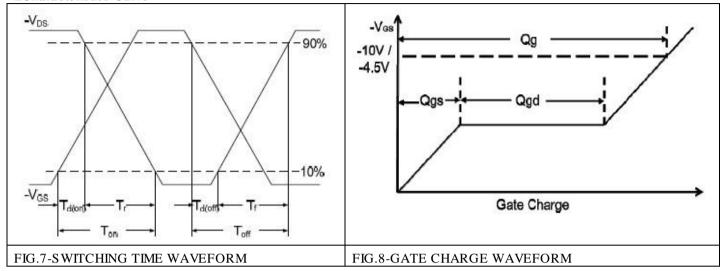




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■Characteristics Curve





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